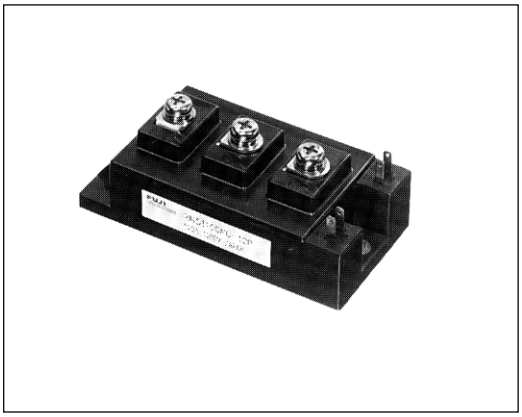
2MBI150SC-120

IGBT Module

1200V / 150A 2 in one-package



■ Features

· High speed switching
· Voltage drive
· Low inductance module structure

■ Applications

· Inverter for Motor drive
· AC and DC Servo drive amplifier
· Uninterruptible power supply
· Industrial machines, such as Welding machines

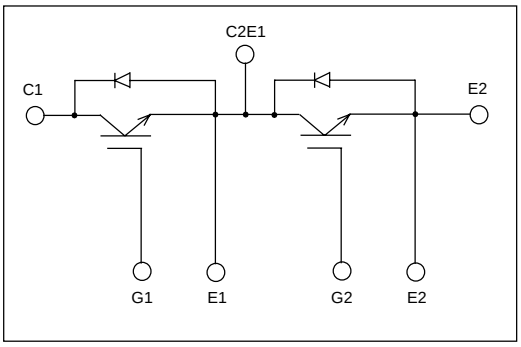
■ Maximum ratings and characteristics

● Absolute maximum ratings (at Tc=25°C unless otherwise specified)

Item			Symbol	Rating	Unit
Collector-Emitter voltage			V_{CES}	1200	V
Gate-Emitter voltaga			V_{GES}	±20	V
Collector current	Continuous	Tc=25°C	I_C	200	A
		Tc=80°C		150	A
	1ms	Tc=25°C	IC pulse	400	A
		Tc=80°C		300	A
			-I_C	150	A
	1ms		-I_C pulse	300	A
Max. power dissipation			P_C	1000	W
Operating temperature			T_j	+150	℃
Storage temperature			T_{stg}	-40 to +125	℃
Isolation voltage *1			V_{is}	AC 2500 (1min.)	V
Screw torque			Mounting *2	3.5	N·m
			Terminals *2	3.5	N·m

*1 : Aii terminals should be connected together when isolation test will be done
*2 : Recommendable value : 2.5 to 3.5 N·m(M5)

■ Equivalent Circuit Schematic



● Electrical characteristics (at Tj=25°C unless otherwise specified)

Item	Symbol	Characteristics			Conditions		Unit
		Min.	Typ.	Max.			
Zero gate voltage collector current	I_{CES}	–	–	2.0	V_{GE}=0V, V_{CE}=1200V		mA
Gate-Emitter leakage current	I_{GES}	–	–	0.4	V_{CE}=0V, V_{GE}=±20V		µA
Gate-Emitter threshold voltage	$V_{GE(th)}$	5.5	7.2	8.5	V_{CE}=20V, I_C=150mA		V
Collector-Emitter saturation voltage	$V_{CE(sat)}$	–	2.3	2.6	Tc=25° C	V_{GE}=15V, I_C=150A	V
		–	2.8	–	Tc=125°C		
Input capacitance	C_{ies}	–	18000	–	V_{GE}=0V		pF
Output capacitance	C_{oes}	–	3750	–	V_{CE}=10V		
Reverse transfer capacitance	C_{res}	–	3300	–	f=1MHz		
Turn-on time	t_{on}	–	0.35	1.2	V_{CC}=600V		µs
	t_r	–	0.25	0.6	I_C=150A		
	$t_{r(i)}$	–	0.1	–	V_{GE}=±15V		
Turn-off time	t_{off}	–	0.45	1.0	R_G=5.6 ohm		
	t_f	–	0.08	0.3			
Forward on voltage	V_F	–	2.3	3.0	Tj=25°C	I_F=150A, V_{GE}=0V	V
		–	2.0	–	Tj=125°C		
Reverse recovery time	t_{rr}	–	–	0.35	I_F=150A		µs

● Thermal resistance characteristics

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Thermal resistance	Rth(j-c)	–	–	0.125	IGBT	°C/W
	Rth(j-c)	–	–	0.26	Diode	°C/W
	Rth(c-f)*2	–	0.025	–	the base to cooling fin	°C/W

*2 : This is the value which is defined mounting on the additional cooling fin with thermal compound